

# Z-PACK | Z-PACK HS3

TE Internal #: 5120658-2

100 Position High Speed Backplane Connector, 10 Row, 10

Column, PCB Mount Header, Vertical, Partially Shrouded, Z-PACK

HS3

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Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors



Number of Positions: 100

Row-to-Row Spacing: 3.5 mm [ .138 in ]

Mating Alignment: With

Mating Alignment Type: Polarization

Number of Rows: 10

# **Features**

# **Product Type Features**

Connector & Contact Terminates To	Printed Circuit Board
Connector System	Board-to-Board
Backplane Module Type	Center
PCB Connector Type	PCB Mount Header
Shroud Style	Partially Shrouded

# **Configuration Features**

Backplane Architecture	Traditional Backplane
Stackable	No
Number of Positions	100
Number of Rows	10
Number of Columns	10
PCB Mount Orientation	Vertical

# **Electrical Characteristics**

Operating Voltage	250 VAC

# Signal Characteristics

Number of Differential Pairs per Column	5
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# **Body Features**

Primary Product Color	Black
Timery Troduct Color	Brack



# **Contact Features**

Contact Mating Area Plating Material Thickness .5 µm[19.68 µin]  Contact Shape & Form Dual Beam  Contact Mating Area Plating Material Tin (Sn)  Contact Mating Area Length 6.8 mm[.268 in]  Contact Base Material Phosphor Bronze  PCB Contact Termination Area Plating Material Tin	PCB Contact Termination Area Plating Material Finish	Matte
Contact Mating Area Plating Material  Contact Mating Area Length  Contact Base Material  Tin (Sn)  6.8 mm[.268 in]  Phosphor Bronze	Contact Mating Area Plating Material Thickness	.5 μm[19.68 μin]
Contact Mating Area Length  Contact Base Material  Contact Base Material  Contact Base Material  Contact Base Material	Contact Shape & Form	Dual Beam
Contact Base Material Phosphor Bronze	Contact Mating Area Plating Material	Tin (Sn)
	Contact Mating Area Length	6.8 mm[.268 in]
PCB Contact Termination Area Plating Material Tin	Contact Base Material	Phosphor Bronze
	PCB Contact Termination Area Plating Material	Tin
Contact Type Pin	Contact Type	Pin
Contact Current Rating (Max) 1.15 A	Contact Current Rating (Max)	1.15 A

#### **Termination Features**

Termination Method to PCB	Through Hole - Press-Fit
Termination Post & Tail Length	3.7 mm[.146 in]

# Mechanical Attachment

Guide Hardware	Without
PCB Mount Retention	With
Mating Retention	Without
PCB Mount Retention Type	Action/Compliant Tail
Mating Alignment	With
Mating Alignment Type	Polarization
Connector Mounting Type	Board Mount

# Housing Features

Number of Shrouded Sides	2
Housing Material	Polyester GF
Centerline (Pitch)	2.5 mm[.098 in]

#### **Dimensions**

PCB Thickness (Recommended)	1.4 mm
Connector Width	24 mm
PCB Hole Diameter	.05 mm[.001 in]
Connector Height	11.95 mm[.47 in]
Connector Length	24.91 mm[.945 in][.981 in]
Row-to-Row Spacing	3.5 mm[.138 in]



#### **Usage Conditions**

Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Tube

# **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

# Product Compliance Disclaimer

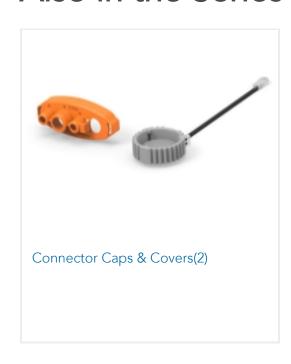
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**





# Also in the Series | Z-PACK HS3







lware(1) H

High Speed Backplane Connectors(39)

# Customers Also Bought





















# **Documents**

# **Product Drawings**

Z-PACK HS3 HDR ASY 10R 100P

English

#### **CAD Files**

**Customer View Model** 

ENG\_CVM\_CVM\_5120658-2\_B.2d\_dxf.zip

English

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_5120658-2\_B.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5120658-2\_B.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

# Datasheets & Catalog Pages

High Speed Backplane Connectors catalog - Z-PACK HS3 Connector

English

# **Product Specifications**

Application Specification

English